

# **Thyristor Module**

= 2x 1600 V

700 A

 $V_{\tau}$ 1.11 V

## Phase leg optional usage as Dual Thyristor Triac

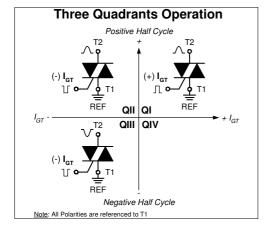
#### Part number

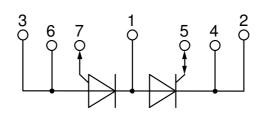
#### MCMA700P1600NCA



Backside: isolated

**F1** E72873





### Features / Advantages:

- Thyristor for line frequency
- Planar passivated chip
- Long-term stability
- Direct Copper Bonded Al2O3-ceramic
- Gate current polarities
  - upper SCR (2 -> 1) = positive/negative
     lower SCR (1 -> 3) = negative

#### **Applications:**

- Line rectifying 50/60 Hz
- Softstart AC motor control
- DC Motor control
- Power converter AC power control
- Lighting and temperature control

#### Package: ComPack

- Isolation Voltage: 4800 V~
- Industry standard outline
- RoHS compliant
- Base plate: Copper internally DCB isolated
- Advanced power cycling
- Phase Change Material available

#### Terms and Conditions of Usage

The data contained in this product data sheet is exclusively intended for technically trained staff. The user will have to evaluate the suitability of the product for the intended application and the completeness of the product data with respect to his application. The specifications of our components may not be considered as an assurance of component characteristics. The information in the valid application- and assembly notes must be considered. Should you require product information in excess of the data given in this product data sheet or which concerns the specific application of your product, please contact your local sales office.

Due to technical requirements our product may contain dangerous substances. For information on the types in question please contact your local sales office.

Should you intend to use the product in aviation, in health or life endangering or life support applications, please notify. For any such application we urgently recommend

to perform joint risk and quality assessments;
the conclusion of quality agreements;

- to establish joint measures of an ongoing product survey, and that we may make delivery dependent on the realization of any such measures.

IXYS reserves the right to change limits, conditions and dimensions.

Data according to IEC 60747 and per semiconductor unless otherwise specified

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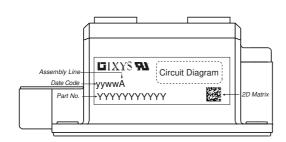


Rectifier				 	Ratings	<b>&gt;</b>	1
Symbol	Definition	Conditions		min.	typ.	max.	Uni
$V_{RSM/DSM}$	max. non-repetitive reverse/forwa	rd blocking voltage	$T_{VJ} = 25^{\circ}C$			1700	!
$V_{RRM/DRM}$	max. repetitive reverse/forward blo	ocking voltage	$T_{VJ} = 25^{\circ}C$			1600	١
I <sub>R/D</sub>	reverse current, drain current	V <sub>R/D</sub> = 1600 V	$T_{VJ} = 25^{\circ}C$			2	m
		$V_{R/D} = 1600 \text{ V}$	$T_{VJ} = 125^{\circ}C$			40	m
V <sub>T</sub>	forward voltage drop	I <sub>T</sub> = 700 A	$T_{VJ} = 25^{\circ}C$			1.16	ļ ,
		I <sub>T</sub> =1400 A				1.41	į ,
		$I_T = 700 \text{ A}$	T <sub>vJ</sub> = 125°C			1.11	<u> </u>
		I <sub>T</sub> =1400 A				1.41	
I <sub>TAV</sub>	average forward current	T <sub>c</sub> = 85°C	T <sub>v.i</sub> = 140°C			700	,
I <sub>T(RMS)</sub>	RMS forward current	180° sine	VJ			1100	
V <sub>T0</sub>	threshold voltage		T <sub>v.i</sub> = 140°C			0.82	١
r <sub>T</sub>	slope resistance for power lo	ss calculation only	1 VJ = 1 10 G			0.4	m۵
R <sub>thJC</sub>	thermal resistance junction to case	•				0.05	1
	thermal resistance junction to case thermal resistance case to heatsing				0.020	0.00	K/V
R <sub>thCH</sub>		IN.	T 25°C		0.020	2200	<u> </u>
P <sub>tot</sub>	total power dissipation	40 mm (50 Hm) -im-	$T_c = 25^{\circ}C$			2300	۷
I <sub>TSM</sub>	max. forward surge current	t = 10 ms; (50 Hz), sine	$T_{VJ} = 45^{\circ}C$			19.0	1
		t = 8,3 ms; (60 Hz), sine	$V_R = 0 V$			20.5	k/
		t = 10 ms; (50 Hz), sine	$T_{VJ} = 140$ °C			16.2	į
		t = 8,3 ms; (60 Hz), sine	$V_R = 0 V$			17.4	k,
l²t	value for fusing	t = 10 ms; (50 Hz), sine	$T_{VJ} = 45^{\circ}C$			1.81	1
		t = 8,3 ms; (60 Hz), sine	$V_R = 0 V$			1.75	
		t = 10 ms; (50 Hz), sine	$T_{VJ} = 140$ °C			1.30	MA <sup>2</sup>
		t = 8.3  ms; (60 Hz), sine	$V_R = 0 V$			1.27	MA <sup>2</sup>
<b>C</b> <sub>J</sub>	junction capacitance	$V_R = 400 V$ $f = 1 MHz$	$T_{VJ} = 25^{\circ}C$		876		pl
P <sub>GM</sub>	max. gate power dissipation	t <sub>P</sub> = 30 μs	T <sub>C</sub> = 140°C			240	٧
		$t_{P} = 300  \mu s$				120	٧
$P_{GAV}$	average gate power dissipation					40	٧
(di/dt) <sub>cr</sub>	critical rate of rise of current	T <sub>v,i</sub> = 140 °C; f = 50 Hz rej	petitive, I <sub>T</sub> =2100 A			100	Α/μ
		$t_P = 200 \mu s; di_G/dt = 1 A/\mu s;$					!
		· · · · · · · · · · · · · · · · · · ·	on-repet., $I_T = 700 \text{ A}$			500	Α/μ
(dv/dt) <sub>cr</sub>	critical rate of rise of voltage	$V = \frac{2}{3} V_{DRM}$	T <sub>v.i</sub> = 140°C			1000	<u> </u>
(acracy)cr		R <sub>GK</sub> = ∞; method 1 (linear voltag	• •				
V <sub>GT</sub>	gate trigger voltage	$V_D = 6 \text{ V}$	$T_{VJ} = 25^{\circ}C$			2	١
▼ GT	gate trigger rollage	V <sub>D</sub> = 0 V	$T_{VJ} = -40$ °C			3	,
	gate trigger current	$V_D = 6 V$	$T_{VJ} = 40^{\circ} \text{G}$ $T_{VJ} = 25^{\circ} \text{C}$				1
I <sub>GT</sub>	gale ingger current	$\mathbf{v}_{D} = \mathbf{o} \ \mathbf{v}$				± 300	m
.,		V 2/ V	$T_{VJ} = -40^{\circ}C$			± 400	m/
V <sub>GD</sub>	gate non-trigger voltage	$V_D = \frac{2}{3} V_{DRM}$	$T_{VJ} = 140^{\circ}C$			0.25	i
I <sub>GD</sub>	gate non-trigger current					± 10	<u> </u>
I <sub>L</sub>	latching current	t <sub>p</sub> = 30 μs	$T_{VJ} = 25^{\circ}C$			400	m/
		$I_G = 1 \text{ A}; \text{ di}_G/\text{dt} = 1 \text{ A}/\mu\text{s}$					1
I <sub>H</sub>	holding current	$V_D = 6 V R_{GK} = \infty$	$T_{VJ} = 25^{\circ}C$			300	m
t <sub>gd</sub>	gate controlled delay time	$V_D = \frac{1}{2} V_{DRM}$	$T_{VJ} = 25 ^{\circ}C$			2	μ
		$I_G = 1 A$ ; $di_G/dt = 1 A/\mu s$					
tq	turn-off time	$V_R = 100 \text{ V}; I_T = 700 \text{ A}; V = \frac{2}{3}$	V <sub>DRM</sub> T <sub>VJ</sub> = 125 °C		350		μ
		$di/dt = 10 A/\mu s dv/dt = 50 V/$	us t = 200 us				1



# MCMA700P1600NCA

Package	kage ComPack		Ratings				
Symbol	Definition	Conditions		min.	typ.	max.	Unit
I <sub>RMS</sub>	RMS current	per terminal				1200	Α
T <sub>VJ</sub>	virtual junction temperature			-40		140	°C
T <sub>op</sub>	operation temperature		-40		125	°C	
T <sub>stg</sub>	storage temperature			-40		125	°C
Weight					500		g
M <sub>D</sub>	mounting torque			3		5	Nm
$\mathbf{M}_{\scriptscriptstyleT}$	terminal torque			12		14	Nm
d <sub>Spp/App</sub>	araanaga diatanaa an ayufaa	e   striking distance through air	terminal to terminal	21.0			mm
d <sub>Spb/Apb</sub>	creepage distance on surface	e   Striking distance through an	terminal to backside	18.0			mm
V <sub>ISOL</sub>	isolation voltage	t = 1 second		4800			٧
1002		t = 1 minute	50/60 Hz, RMS; lisoL ≤ 1 mA	4000			٧



#### Part description

M = Module
C = Thyristor (SCR)
M = Thyristor
A = (up to 1800V)
700 = Current Rating [A]
P = Phase leg 1600 = Reverse Voltage [V]

N = Three Quadrants operation: QI - QIII CA = ComPack

Ordering	Ordering Number	Marking on Product	Delivery Mode	Quantity	Code No.
Standard	MCMA700P1600NCA	MCMA700P1600NCA	Box	3	515494

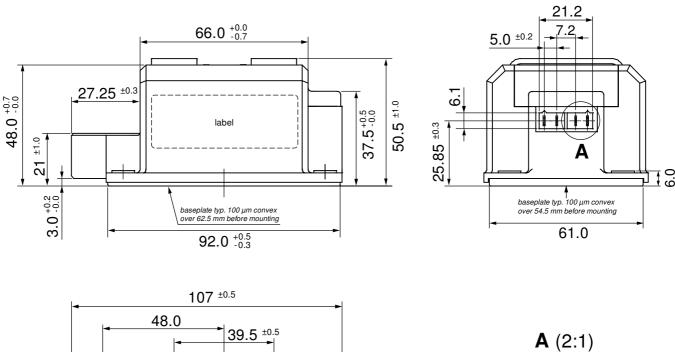
Similar Part	Package	Voltage class
MCMA700P1600CA	ComPack	1600

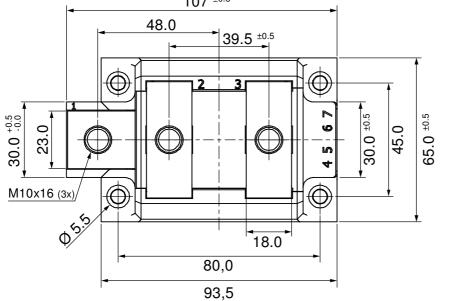
Equiva	alent Circuits for	Simulation	* on die level	T <sub>VJ</sub> = 140 °C
$I \rightarrow V_0$	R <sub>o</sub> -	Thyristor		
V <sub>0 max</sub>	threshold voltage	0.82		V
$R_{0 \text{ max}}$	slope resistance *	0.21		$m\Omega$

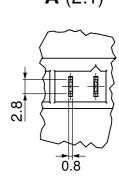


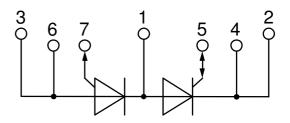


### **Outlines ComPack**











### **Thyristor**

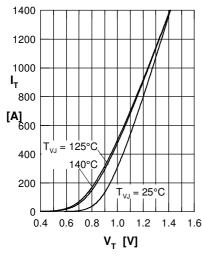


Fig. 1 Forward characteristics

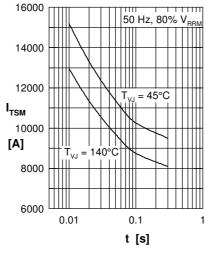


Fig. 2 Surge overload current  $I_{TSM}$ : crest value, t: duration

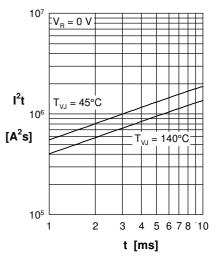


Fig. 3 I<sup>2</sup>t versus time (1-10 s)

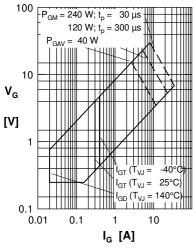


Fig. 4 Gate voltage & gate current

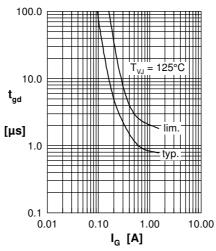


Fig. 5 Gate controlled delay time t<sub>ad</sub>

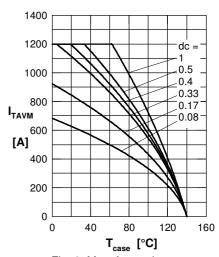


Fig. 6 Max. forward current at case temperature

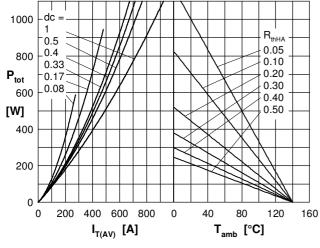


Fig. 7a Power dissipation versus direct output current

Fig. 7b and ambient temperature

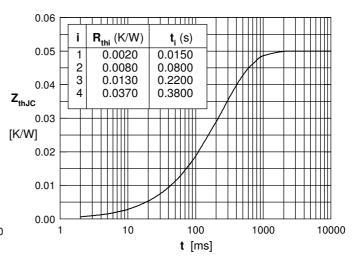


Fig. 8 Transient thermal impedance junction to case